

SF1141B-4

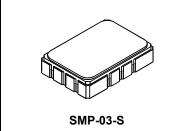
- Designed for SDARS IF Receiver
- · Low Insertion Loss
- 5.0 X 7.0 mm Surface-Mount Case
- · Differential Input and Output
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

| , about a maximum raumgo                |            |                |  |  |
|---|------------|----------------|--|--|
| Rating                                  | Value      | Units          |  |  |
| Maximum Incident Power in Passband      | +10        | dBm            |  |  |
| Max. DC voltage between any 2 terminals | 30         | VDC            |  |  |
| Storage Temperature Range               | -40 to +85 | °C             |  |  |
| Max Soldering Profile                   | 265°C      | 265°C for 10 s |  |  |





#### **Electrical Characteristics**

| Characteristic   |                         | Sym                                  | Notes   | Min                 | Тур    | Max  | Units             |
|--|-------------------------|--------------------------------------|---------|---------------------|--------|------|-------------------|
| Nominal Center Frequency                                 |                         | f <sub>C</sub>                       | 1       | 75.000              |        | MHz  |                   |
| Passband Insertion Loss at fo                            |                         | IL                                   | '       |                     | 12.5   | 16.0 | dB                |
|  | 1dB Passband            | BW <sub>1</sub>                      |         | ±6.35               | ±7.43  |      | MHz               |
| Fast Amplitude Ripple over fc ±6.35 MHz                  |                         |                                      | 1, 2    |                     |        | 1.5  | dB <sub>P-P</sub> |
| Group Delay Variation over fc ±6.35 MHz                  |                         |                                      |         |                     | 75     | 200  | ns <sub>P-P</sub> |
| Rejection  | fc-100 to fc-18.8 MHz   |                                      |         | 40                  | 45     |      |                   |
|  | fc-18.8 to fc-10.95 MHz |                                      | 1, 2, 3 | 37                  | 45     |      | dB                |
|  | fc+10.95 to fc+18.8 MHz |                                      | 1, 2, 3 | 30                  | 36     |      | ив                |
|  | fc+18.8 to fc+100 MHz   |                                      |         | 40                  | 45     |      |                   |
| Operating Temperature Range                              |                         | T <sub>A</sub>                       | 1       | -40                 |        | +85  | °C                |
| Differential Input an                                    | d Output Impedance      | 250 ohms                             |         | •                   |        |      |                   |
| Case Style   |                         | 6 SMP-03-S 7 x 5 mm Nominal Footprin |         |                     | tprint |      |                   |
| Lid Symbolization (YY=year, WW=week, S=shift) See note 4 |                         |                                      |         | RFM SF1141B-4 YYWWS |        |      |                   |

#### **Electrical Connections**

| Connection | Port 1 Hot | Port 1 Ground Return or Hot | Port 2 Hot | Port 2 Ground Return or Hot | Case Ground |
|------------|------------|-----------------------------|------------|-----------------------------|-------------|
| Terminals  | 10         | 1                           | 5          | 6                           | All Others  |

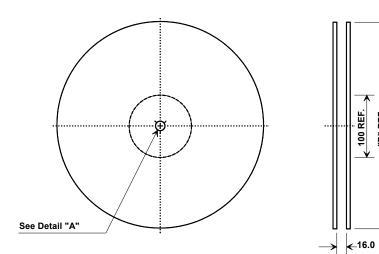


### CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

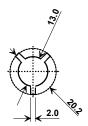
#### NOTES:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to  $50~\Omega$  and measured with  $50~\Omega$  network analyzer. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. The design, manufacturing process, and specifications of this filter are subject to change. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design. US and international patents may apply.
- 4.

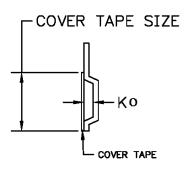
# **Tape and Reel Specifications**



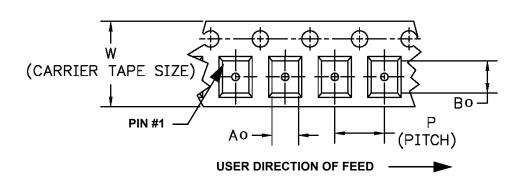
| "B "<br>Nominal Size |             | Quantity Per Reel |
|----------------------|-------------|-------------------|
| Inches               | millimeters |                   |
| 7                    | 178         | 500               |
| 13                   | 330         | 2000              |



# **COMPONENT ORIENTATION and DIMENSIONS**

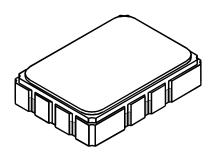


| Carrier Tape Dimens | Tolerance |         |
|---------------------|-----------|---------|
| Ao                  | 5.5 mm    | ± 0.1mm |
| Во                  | 7.5 mm    | ± 0.1mm |
| Ко                  | 2.0 mm    | ± 0.1mm |
| Pitch               | 8.0 mm    | ± 0.1mm |
| W                   | 16.0 mm   | ± 0.2mm |



# SMP-03-S Case (%)

# 12-Terminal Ceramic Surface-Mount Case 5 x 7 mm Nominal Footprint



| Case Dimensions |      |      |      |        |       |       |
|-----------------|------|------|------|--------|-------|-------|
| Dimension       | mm   |      |      | Inches |       |       |
|                 | Min  | Nom  | Max  | Min    | Nom   | Max   |
| Α               | 6.80 | 7.00 | 7.20 | 0.268  | 0.276 | 0.283 |
| В               | 4.80 | 5.00 | 5.20 | 0.189  | 0.197 | 0.205 |
| С               |      | 1.65 | 2.00 |        | 0.065 | 0.079 |
| D               |      | 0.80 |      |        |       |       |
| E               | 2.41 | 2.54 | 2.67 | 0.095  | 0.100 | 0.105 |
| Н               | 0.87 | 1.1  | 1.13 | 0.034  | 0.039 | 0.044 |
| J               |      | 2.54 |      |        |       |       |
| K               | 2.87 | 3.00 | 3.13 | 0.113  | 0.118 | 0.123 |
| P               | 1.14 | 1.27 | 1.40 | 0.045  | 0.050 | 0.055 |

|                           | Materials  |  |  |  |
|---------------------------|--|--|--|--|
| Solder Pad<br>Termination | Au plating 30 - 60 μinches (76.2-152 μm) over 80-200 μinches (203-508 μm) Ni.    |  |  |  |
| Lid                       | Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µinches Thick |  |  |  |
| Body                      | Al <sub>2</sub> O <sub>3</sub> Ceramic   |  |  |  |
| Pb Free                   |  |  |  |  |

